

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1 (currently amended): A cooler with a circulating cooling liquid for cooling a heating element of an electronic device ~~which cools a heating element provided on the electronic device~~ comprising:

a substrate;

a liquid cooling mechanism, composed of:

a flat-shape heat sink ~~formed in a flat shape~~ with a liquid channel therein having to have a heat-receiving face ~~to be~~ made in contact with said heating element,

a pump portion with a flat-shape housing having an impeller rotatably provided therein a ~~flat-shape~~ to circulate said cooling liquid,

a plurality of metal pipes connected to the liquid channel for circulating said cooling liquid;

a forcible air cooling mechanism, composed of:

a radiating fin provided on ~~outer surfaces of~~ said metal pipes and

a fan to cool said radiating fin and said flat-shape housing,

wherein said pump portion ~~of the liquid cooling mechanism~~ and said fan ~~of the forcible air cooling mechanism being~~ are provided on the substrate in ~~a vertically aligned positional relationship such~~ so that said liquid cooling mechanism ~~and~~ is integrated with said forcible air cooling mechanism ~~are unified~~.

Claim 2 (Currently amended): The cooler for an electronic device as claimed in Claim 1, wherein an axis of rotation of said impeller and an axis of rotation of said fan are co-linear ~~are arranged in such a manner that the axis of the rotation of the impeller forming said liquid cooling mechanism and the axis of the rotation of the fan forming said forcible air cooling mechanism are positioned on an identical line.~~

Claim 3 (Currently amended): The cooler for an electronic device as claimed in Claim 1 or 2, wherein said fan and said impeller are rotated together as each is under an influence of a magnetic force.

Claim 4 (Currently amended): The cooler for an electronic device as claimed in Claim 3, wherein a an active magnet asserting a magnetic force ~~for rotating the fan which rotates under the~~ an influence of ~~the~~ a magnetic fluctuation of ~~the~~ a motor substrate to rotate the fan and a magnet for driving the impeller are is placed ~~on~~ above said fan, while a the passive magnet with a magnetic

force influenced by ~~which receives the magnetic force from said magnet for driving the impeller,~~
~~is placed on said impeller.~~

Claim 5 (Currently amended): The cooler for an electronic device as claimed in Claim 3, wherein a an active magnet asserting a magnetic force ~~for rotating the fan which rotates~~ under the an influence of the a magnetic fluctuation of the motor substrate to rotate the fan is placed ~~on~~ above said fan, while a passive magnet ~~which receives~~ with a magnetic force influenced by the magnetic force of said active magnet for rotating the fan is placed ~~on~~ above said impeller ~~such that so as to~~ allow said fan and said impeller ~~are~~ to rotated together.

Claim 6 (Currently amended): The cooler for an electronic device as claimed in Claim 4, wherein said motor substrate is made of an insulating plate having a coil ~~formed on the surface thereof,~~ said fan is being in the form of a thin plate having a plurality of bent blades on the a periphery of a thin plate having a rotation axis at the a middle portion thereof, and said motor substrate, said fan and said pump portion in a flat form ~~are~~ being laminated on each other.

Claim 7 (Currently amended): The cooler for an electronic device as claimed in Claim 1, wherein the plurality of metal pipes each connecting the pump portion to the liquid channel of the heat sink are folded at least once between the pump portion and the heat sink, and said radiating fin is ~~placed~~ disposed between the folded metal pipes.

Claim 8 (Currently amended): The cooler for an electronic device as claimed in Claim 7, wherein said radiating fin and the portions of said plurality of metal pipes on which the radiating fin is placed are mounted on, and in contact with, a mounting plate having the housing provided thereon to form the pump portion.

Claim 9 (Currently amended): The cooler for an electronic device as claimed in Claim 8, wherein a port capable of ~~having~~ allowing air passing through ~~being passed therethrough~~ is formed on at least one portion of the mounting plate where the radiating fin is positioned.

Claim 10 (Currently amended): The cooler for an electronic device as claimed in Claim 1, wherein the heat sink is made of aluminum ~~which is a highly heat-conductive material~~, and ~~that~~ the metal pipe is made of copper.

Claim 11 (Currently amended): The cooler for an electronic device as claimed in Claim 5, wherein said motor substrate is made of an insulating plate having a coil ~~formed on the surface thereof~~, said fan is in the form of a thin plate having a plurality of bent blades on ~~the~~ a periphery of ~~a the~~ a thin plate having a rotation axis at ~~the a~~ a middle portion ~~thereof~~, and said motor substrate, said fan and said pump portion in a flat form are laminated on each other.